MOTOROLA SEMICONDUCTOR TECHNICAL DATA

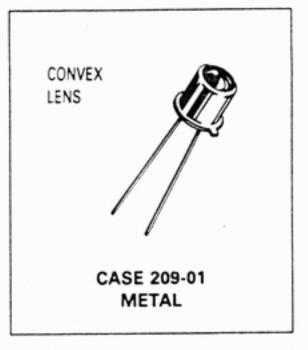
Infrared LED

... designed for applications requiring high power output, low drive power and very fast response time. This device is used in industrial processing and control, light modulators, shaft or position encoders, punched card readers, optical switching, and logic circuits. It is spectrally matched for use with silicon detectors.

- High-Power Output 4 mW (Typ) @ IF = 100 mA, Pulsed
- Infrared-Emission 940 nm (Typ)
- Low Drive Current 10 mA for 450 μW (Typ)
- Popular TO-18 Type Package for Easy Handling and Mounting
- Hermetic Metal Package for Stability and Reliability

MLED930

LED 940 nm



MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Reverse Voltage	VR	6	Volts	
Forward Current — Continuous	İF	60	mA	
Forward Current — Peak Pulse (PW = 100 \(mu\)s, d.c. = 2%)	lF	I _F 1		
Total Device Dissipation @ T _A = 25°C Derate above 25°C (Note 1)	PD	250 2.27	mW mW/°C	
Operating Temperature Range	TA	- 55 to + 125	°C	
Storage Temperature Range	T _{stg}	- 65 to + 150	°C	

ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted)

Characteristic	Fig. No.	Symbol	Min	Тур	Max	Unit
Reverse Leakage Current (V _R = 3 V)	_	IR	_	2	_	nA
Reverse Breakdown Voltage (I _R = 100 μA)	_	V _{(BR)R}	6	20	_	Volts
Forward Voltage (IF = 50 mA)	2	VF	_	1.32	1.5	Volts
Total Capacitance (V _R = 0 V, f = 1 MHz)	_	СТ		18	_	pF

OPTICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Total Power Output (Note 2) (I _F = 60 mA, dc) (I _F = 100 mA, PW = 100 μs, duty cycle = 2%)	3, 4	Po	1	2.5 4	_	mW
Radiant Intensity (Note 3) (I _F = 100 mA, PW = 100 μs, duty cycle = 2%)	_	Io	_	1.5	_	mW/ steradian
Peak Emission Wavelength	1	λР	_	940	_	nm
Spectral Line Half Width	1	Δλ	_	40	_	nm

Notes: 1. Printed Circuit Board Mounting

- Power Output, P_O, is the total power radiated by the device into a solid angle of 2π steradians. It is measured by directing all radiation leaving the device, within this solid angle, onto a calibrated silicon solar cell.
- 3. Irradiance from a Light Emitting Diode (LED) can be calculated by:
 - le where H is irradiance in mW/cm²; le is radiant intensity in mW/steradian;

H = -

d² is distance from LED to the detector in cm.

MLED930

TYPICAL CHARACTERISTICS

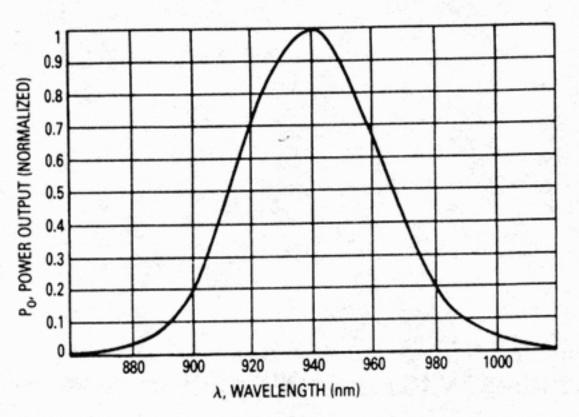


Figure 1. Relative Spectral Output

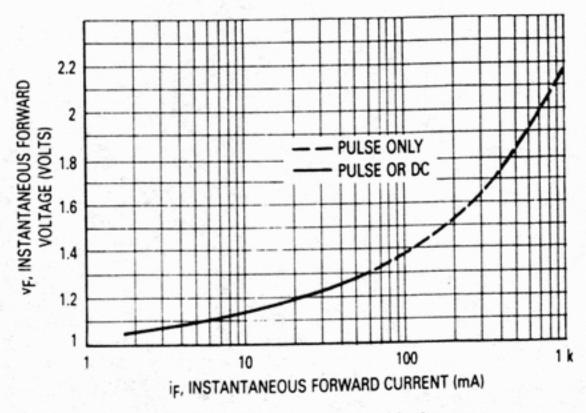


Figure 2. Forward Characteristics

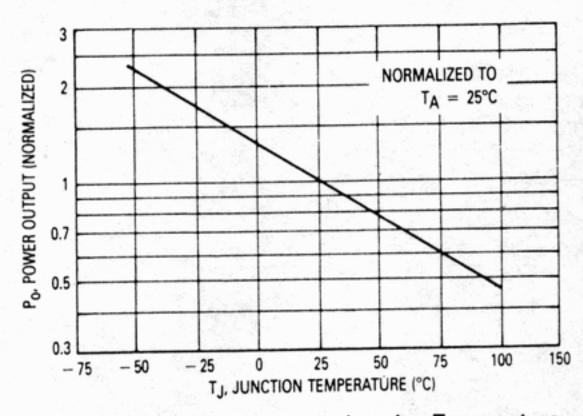


Figure 3. Power Output versus Junction Temperature

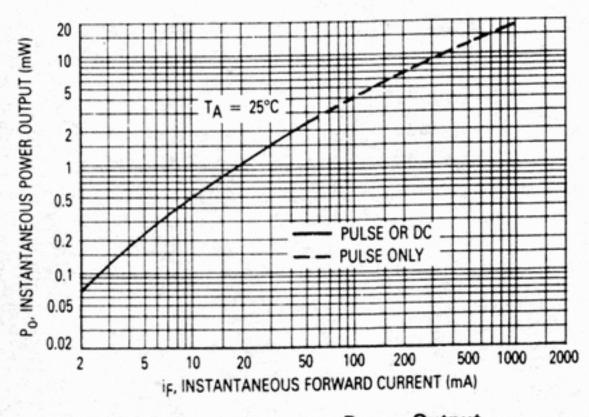


Figure 4. Instantaneous Power Output versus Forward Current

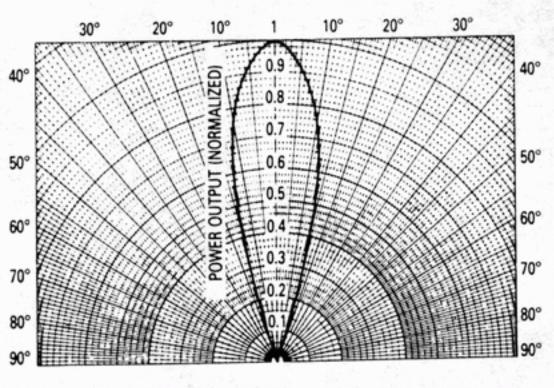


Figure 5. Spatial Radiation Pattern

OUTLINE DIMENSIONS

2. LEA	ADS WITH	IN 0.13 m	m (0.005) S PLANE	RADIUS (AT MAXIM	OF TRUE
	MILLIMETERS		S INCHES		SEATING
DIM	MIN	MAX	MIN	MAX	
A	5.31	5.84	0.209	0.230	U U
В	4.52	4.95	0.178	0.195	0-
C	5.08	6.35	0.200	0.250	(H)
D	0.41	0.48	0.016	0.019	CD05.
F	0.51	1.02	0.020	0.040	STYLE 1:
G	2.54	BSC	0.100	BSC	PIN 1. ANODE
н	0.99	1.17	0.039	0.046	2. CATHODE
J	0.84	1.22	0.033	0.048	
K	12.70	_	0.500	-	
L	3.35	4.01	0.132	0.158	CASE 209-01
м	45° BSC		45° BSC		METAL